



体外诊断用芯片 (微流控) 积层及黏着

In-vitro Diagnostic Chip (Microfluidics) Layers and Adhesion

对于制作微流控板与芯片时的积层及黏着方法，可进行提案。

We propose a layering and adhesion method for chips and plates.

通过全球性的生产系统，构筑能在全世界任何地方提供相同服务的网络。

为了满足广大客户需求，还设有无尘室（100级）。从试制品的开发到量产化，我们将通过可令人放心委托的“品质”、“成本”及“速度”，全力支持客户的产品制造。

With our global production system, we have built a network to provide the same service anywhere in the world. To meet a wide range of customer needs, we also have a clean room (Class 100), which allows customers to commission work to us worry free from the development of prototypes to mass production to support our customer's production in terms of quality, costs, and speed.



最合适的材料提案 Optimum Materials Proposal

通过供应网络在各种材料厂商之中选定并提案最合适的材料

We select and propose the optimum material using our supplier network of manufacturers that offer a wide range of materials.

- 独立系厂家（非某系统厂家）
- 与材料厂家拥有稳定的关系
- 材料开发能力（原创材料）
- Independent manufacturer (non-corporate group)
- Strong relationship with materials manufacturers
- Material development capability (original materials)



最合适的加工提案 Optimum Processing Proposal

使用本公司的核心技术「SOFT PRESS」技术，能自由地为材料进行高精度的超细微加工

Materials can be freely processed using high-accuracy ultra-fine processing by employing our "Soft Press" technology, which is one of our core technologies.

- 单层及复合材料皆可适用
- 对于难以加工的材料也可提供方案
- 无尘室设施完善
- Both single layers and compound materials can be processed
- Please consult with us regarding difficult to process materials
- Fully equipped clean room



黏着技术提案 Adhesion Technology Proposal

拥有各种加工技术可应对客户在键合方法上所遇到的课题

We possess various processing technologies and can resolve your bonding method issues.

- 贴合技术（贴合方法）
- 黏着技术（非同类材料之间也可进行）
- 焊接技术（材料知识）
- Affixing technology (lamination method)
- Adhesion technology (between different material types as well)
- Fusion technology (knowledge about materials)

